# 502553064 10/31/2013

## PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

# **CONVEYING PARTY DATA**

Name	Execution Date
TOKYO DENPA CO., LTD.	10/29/2013

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#### PROPERTY NUMBERS Total: 1

Property Type	Number
Patent Number:	7438762

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ATTORNEY DOCKET NUMBER: 85482.0002 PATENT

502553064 REEL: 031520 FRAME: 0573

NAME OF SUBMITTER:	SAYAKA KARASAWA
Signature:	/Sayaka Karasawa/
Date:	10/31/2013
Total Attachments: 1 source=85482_0002_Assignment#page1.tif	

PATENT REEL: 031520 FRAME: 0574

#### ASSIGNMENT

WHEREAS, Tokyo Denpa Co., Ltd., a corporation of Japan, whose post office address is 1-12-18 Omorinishi, Ota-Ku, Tokyo 143-0015, Japan (hereinafter referred to as Assignor), owns, by assignment, 35% of the entire right, title, and interest in U.S. Letters Patent No. 7,438,762, entitled "MANUFACTURE METHOD FOR ZnO BASED COMPOUND SEMICONDUCTOR CRYSTAL AND ZnO BASED COMPOUND SEMICONDUCTOR SUBSTRATE" (hereinafter referred to as the '762 Patent);

Tokyo Denpa Co., Ltd. also owns, by assignment, 35% of all right, title, and interest in U.S. Letters Patent No. 7,829,207, entitled "MANUFACTURE METHOD FOR ZnO BASED COMPOUND SEMICONDUCTOR CRYSTAL AND ZnO BASED COMPOUND SEMICONDUCTOR SUBSTRATE" (hereinafter referred to as the '207 Patent); and

Stanley Electric Co. Ltd., a corporation of Japan, whose post office address is 2-9-13, Nakameguro, Meguro-ku, Tokyo 153-8636, Japan, (hereinafter referred to as Stanley Electric), owner of 35% of all right, title, and interest in each of the '762 Patent and the '207 Patent, and Tohoku University, a university of Japan, whose post office address is 1-1, Katahira 2-chome, Aoba-ku, Sendai-shi, Miyagi 980-8577 (hereinafter referred to as Tohoku University), owner of 30% of all right, title, and interest in each of the '762 Patent and the '207 Patent, desire to own collectively Tokyo Denpa's entire right, title, and interest in and to the '762 Patent and the '207 Patent.

NOW THEREFORE, be it known that, for good and valuable consideration, the receipt of which from Assignee is hereby acknowledged, Assignor (Tokyo Denpa) hereby sells and assigns to Stanley Electric a half (17.5%) of its entire right, title, and interest in the '762 Patent, and hereby sells and assigns to Tohoku University the remaining half (17.5%) of its entire right, title, and interest in the '762 Patent, to be held and enjoyed by Staley Electric and Tohoku University, their successors, and assigns, as fully and entirely as the same would have been held and enjoyed by Assignor had this assignment and sale not been made.

Be it also known that, for good and valuable consideration, the receipt of which from Assignee is hereby acknowledged, Assignor (Tokyo Denpa) hereby sells and assigns to Stanley Electric a half (17.5%) of its entire right, title, and interest in the '207 Patent, and hereby sells and assigns to Tohoku University the remaining half (17.5%) of its entire right, title, and interest in the '207 Patent, to be held and enjoyed by Staley Electric and Tohoku University, their successors, and assigns, as fully and entirely as the same would have been held and enjoyed by Assignor had this assignment and sale not been made.

IN TESTIMONY WHEREOF, Tokyo Denpa has caused this assignment to be signed by its duly authorized representative.

Assignor	Assignor's Signature	Date:
Tokyo Denpa Co., Ltd.	J. Itu	
	Printed Name:	Oct. 29, 2013
	Takahiro ITO	
	Title:	
	Senior Manager, Administration department	
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Chen Yoshimura LLP

PATENT REEL: 031520 FRAME: 0575

**RECORDED: 10/31/2013**